# M.E. PRODUCTION ENGINEERING FIRST YEAR SECOND SEMESTER EXAMINATION 2017

Subject: Nano-Technology & Micro-Machining

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Full Marks: 100

# PART I

(40 for Part I)

### Answer Any Two Questions

Answer Any Two Questions	
Q1 a) What is Micro-machining? Differentiate between Bulk and Surface Micro-machining. What is a M Electro Mechanical system (MEMS)? Describe the essential elements of MEMS.	licro 10
b) Briefly explain the following process in respect of micro manufacturing: i) Etching	6
c) Define Nano-material. What is a two dimensional Nano-material?	4
Q2. a) Briefly discuss the characteristics of Physical Vapour deposition techniques.	4
b) With suitable diagrams explain the following deposition processes: i) Casting, ii) Electroplating, iii) Sputtering and iv) Thermal Oxidation.	16
Q3. a ) Explain how mirror surface finish can be achieved by ELID grinding. Make a comparative analysis of ELID grinding & Electro Chemical Grinding process.	12
b) With suitable diagrams explain the principle of Atomic Force Microscopy	g

# MASTER OF PRODUCTION ENGG. EXAMINATION, 2017 $(2^{nd}\ Semester)$ SUBJECT – NANO-TECHNOLOGY AND MICRO-MACHINING

Time: Three hours

Full Marks: 60

Use a separate answer-script for each part.

No of Questions	PART- II	Marks
and the process of the second	Answer any <i>three</i> questions	
1	<ul><li>(a) Define "Nano-Technology" and "Micro-Machining".</li><li>(b) What are the differences in basic manufacturing approaches for Micro-Machining</li></ul>	6
	and Nano-Technology?  (c) Highlight on various measuring techniques utilized at different level of progress in	6
	the achievable machining accuracy.	8
2.	<ul><li>(a) What are the major disadvantages of Tool Based Micro-Machining?</li><li>(b) Describe the basic concept of Atomic-Bit Materials processing and also explain</li></ul>	4
	two basic ultraprecision polishing techniques of atomic bit size chip removal process.  (c) Describe the basic concept of Magneto Rheological Finishing (MRF) process and	8
	identify the advantages of MRF method over other ultraprecision polishing techniques	. 8
3.	(a) Define Electrochemical Micromachining (EMM) and explain advantages of EMM over other micro-machining methods.	6
. *	(b) Explain EMM system with detail of various sub-systems.	8
-	(c) Identify major process parameters which influence the performance criteria of EMM system.	6
4.	(a) Discuss two most important developments in conventional Electro discharge Machining (EDM) Process which promote EDM for micro machining application.	4
	(b) Classify and explain various micro-EDM methods.	6
	(c) Highlight various problems related to micro electrodes in Micro-EDM.	4
	(d) Describe in brief micro-electrode preparation devices utilizing micro-EDM.	6
5.	Write short notes on (any two):	
	(i) Micro-WEDM, (ii) Laser Micro Machining,	
	(iii) Hybrid micro-machining,	
	(iv) Abrasive flow finishing.	2 X 10